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<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> (use as many sheets as necessary)		Application Number	10/056,054
		Filing Date	January 28, 2002
		First Named Inventor	Shunpei YAMAZAKI et al.
		Group Art Unit	2812
		Examiner Name	Unassigned
Sheet		Attorney Docket Number	0756-2427

U.S. PATENT DOCUMENTS						
Examiner Initials <sup>1</sup>	Cite No. <sup>1</sup>	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number	Kind Code <sup>2</sup> (if known)			
TSP		5,643,826		Ohtani et al.	07/01/97	
TSP		5,923,962		Ohtani et al.	07/13/99	
TSP		6,285,042		Ohtani et al.	09/04/01	
TSP		6,335,541		Ohtani et al.	01/01/02	

FOREIGN PATENT DOCUMENTS							
Examiner Initials <sup>1</sup>	Cite No. <sup>1</sup>	Foreign Patent Document			Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Office <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup> (if known)			
TSP		EP	0 651 431			05/03/95	English
TSP		JP	07-183540			07/21/95	Abst.

OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS			
Examiner Initials <sup>1</sup>	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>2</sup>
TSP		Specification, Drawings, Abstract and Claims of Application Serial No. 10/078,240 filed February 20, 2002 entitled Method of Manufacturing a Semiconductor Device	
TSP		Specification, Drawings, Abstract and Claims of Application Serial No. 10/081,767 filed February 25, 2002, entitled Method of Manufacturing a Semiconductor Device	

Examiner Signature		Date Considered	6/18/03
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<sup>1</sup> Unique citation designation number. <sup>2</sup> See attached Kinds of U.S. Patent Documents. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

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